

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Panasonic

8 GHz max. capable, 150 W carrying power (at 2 GHz), compact SMD type, 50Ω impedance and 1 Form C relays

RN RELAYS (ARN)



Protective construction: Flux-resistant type

RoHS compliant

FEATURES

- 1. 150 W carrying power possible (at 2GHz)
- 2. Excellent high frequency characteristics, 6 GHz capable Low insertion loss: Max. 0.12 dB (at 2GHz)
- 3. Miniature size and Surface mount (SMD) type

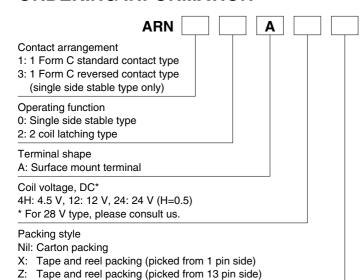
L: 9.6 × W: 14.6 × H: 10 mm L: .378 × W: .575 × H: .394 inch

TYPICAL APPLICATIONS

- Base stations market
 Mobile phone, transmitter section of terrestrial digital base stations, etc.
- Measuring equipment market Spectrum analyzer and oscilloscope, etc.
- Other applications
 High-frequency amp switching in wireless devices, etc.

If you consider using applications with low level loads or with high frequency switching, please consult us.

ORDERING INFORMATION



TYPES

1. Single side stable type

Contact organization	Nominal coil voltage	Part No.		
Contact arrangement		Standard contact type	Reversed contact type	
1 Form C	4.5 V DC	ARN10A4H	ARN30A4H	
	12 V DC	ARN10A12	ARN30A12	
	24 V DC	ARN10A24	ARN30A24	

Standard packing: 50 pcs. in an inner package (carton); 500 pcs. in an outer package

2. 2 coil latching type

5 71					
	Contact arrangement	Naminal acil valtage	Part No.		
		Nominal coil voltage	Standard contact type		
		4.5 V DC	ARN12A4H		
	1 Form C	12 V DC	ARN12A12		
		24 V DC	ARN12A24		

Standard packing: 50 pcs. in an inner package (carton); 500 pcs. in an outer package

3. Single side stable type

Contact arrangement	Nominal coil voltage	Part No.		
		Standard contact type	Reversed contact type	
	4.5 V DC	ARN10A4H□	ARN30A4H□	
1 Form C	12 V DC	ARN10A12□	ARN30A12□	
	24 V DC	ARN10A24□	ARN30A24□	

4. 2 coil latching type

Contact arrangement	Nominal coil voltage	Part No.
		Standard contact type
1 Form C	4.5 V DC	ARN12A4H□
	12 V DC	ARN12A12□
	24 V DC	ARN12A24□

Standard packing: 400 pcs. in an inner package (tape and reel); 800 pcs. in an outer package

RATING

1. Coil data

1) Single side stable type

Nominal coil voltage	Pick-up voltage (at 20°C 68°F)	Drop-out voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. applied voltage (at 85°C 185°F)
4.5 V DC	75%V or less of	10%V or more of	71.1 mA	63.3 Ω		1400/1/ (
12 V DC	nominal voltage	nominal voltage	26.7 mA	450 Ω	320 mW	110%V of nominal voltage
24 V DC	(Initial)	(Initial)	13.3 mA	1,800 Ω		nominal voltage

2) 2 coil latching type

Nominal coil voltage	Set voltage (at 20°C 68°F)	Reset voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. applied voltage (at 85°C 185°F)
4.5 V DC	75%V or less of	75%V or less of	88.9 mA	50.6 Ω		1400/1/ (
12 V DC	nominal voltage		33.3 mA	360 Ω	400 mW	110%V of nominal voltage
24 V DC	(Initial)		16.7 mA	1,440 Ω		

2. Specifications

Characteristics		Item	Specifications				
	Arrangement		1 Form C				
Contact	Contact mater	ial		Gold p	olating		
	Contact resista	ance (Initial)		Max. 100 mΩ (By voltage	ge drop 10 V AC 10mA)		
	Nominal switch	hing capacity	80'	W (at 2 GHz, Impedance	e 50Ω, V.S.W.R. Max.1.1	5)	
Rating	Contact carrying	ng power (CW)*1		Max.150W (at 20°C 68°F) (at 2 GHz, Impedance 50Ω, V.S.W.R. Max.1.15, with heat sink) Max.100W (at 20°C 68°F) (at 2 GHz, Impedance 50Ω, V.S.W.R. Max.1.15, without heat sink)			
	Nominal opera	ating power	Single	side stable type: 320 mV	N, 2 coil latching type: 4	00 mW	
			to 1 GHz	1 to 2 GHz	2 to 3 GHz	3 to 6 GHz	
High frequency characteristics	V.S.W.R. (Max)	1.1	1.15	1.2	1.3	
(to 6 GHz)	Insertion loss	(without D.U.T. board's loss, dB, Max.)	0.1	0.12	0.15	0.5	
	Isolation (dB, I	Min.)	60	55	45	30	
	Insulation resis	stance (Initial)	Min. 1,000 MΩ (at 500\	VDC, Measurement at s	same location as "Break	down voltage" section.)	
	Breakdown	Between open contacts	500 AC Vrms for 1min. (Detection current: 10mA)				
	voltage	Between contact and earth terminal	500 AC Vrms for 1min. (Detection current: 10mA)				
Electrical	(Initial)	Between contact and coil	500 AC Vrms for 1min. (Detection current: 10mA)				
characteristics	Operate time [Set time] (at 20°C 68°F)	Max. 5 ms (Non	ninal voltage applied to t	the coil, excluding conta	ct bounce time)	
	Release time [Reset time] (at 20°C 68°F)		bounce time)*2	Max. 5 ms (Nominal vo	,	Ü	
	Shock resistance Punctional Destructive		Min. 490 m/s ²	(Half-wave pulse of sin	e wave: 11 ms, detection	n time: 10 μs)	
Mechanical			Min. 980 m/s² (Half-wave pulse of sine wave: 6 ms)				
characteristics	Vibration Functional		10 to 55 Hz at double amplitude of 3 mm .118 inch (Detection time: 10 μs)				
	resistance Destructive		10 to 55 Hz at double amplitude of 5 mm .197 inch				
	Mechanical life		Min. 1×10 ⁶ (at 180 cpm)				
Expected life Electrical life (at 20 cpm)		 1×10⁶ ope. at 10mA 10 VDC resistive load, 1×10⁶ ope. at 1W High frequency load (at 2 GHz, Impedance 50Ω, V.S.W.R. Max.1.15), 1×10³ ope. at 80 W High frequency load, operating frequency 5.0s ON, 5.0s OFF (at 2 GHz, Impedance 50Ω, V.S.W.R. Max.1.15, at 20°C 68°F, with heatsink) 					
	Conditions for operation, transport and storage		Ambient temperature: -40 to $+85^{\circ}$ C -40 to $+185^{\circ}$ F, Humidity: 5 to 85% R.H. (Not freezing and condensing at low temperature)				
Conditions	Conditions for	operation, transport and storage					

Standard packing: 400 pcs. in an inner package (tape and reel); 800 pcs. in an outer package

* Please add an X (picked from 1 pin side) or Z (picked from 13 pin side) at the end of the part number when ordering.

* Packing style symbol "X", "Z" is not marked on the relay.

^{*} Please add an X (picked from 1 pin side) or Z (picked from 13 pin side) at the end of the part number when ordering.

^{*} Packing style symbol "X", "Z" is not marked on the relay.

Notes: *1. Since the design of the PC board and heat dispersion conditions affect contact carrying power, please verify under actual conditions. *2. Release time will leng then if a diode, etc., is connected in parallel to the coil. Be sure to verify operation under actual conditions.

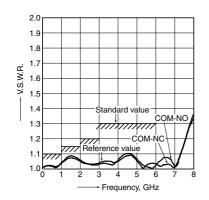
REFERENCE DATA

1. High frequency characteristics

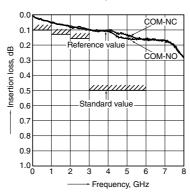
Sample: ARN10A12

Measuring method: Measured with Agilent Technologies network analyzer (E8363B). *For details, see "9. Measuring method" under "NOTES".

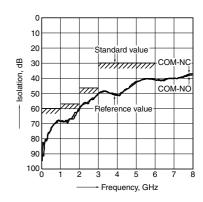
V.S.W.R. characteristics



 Insertion loss characteristics (without D.U.T. board's loss)

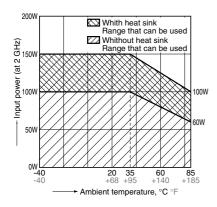


· Isolation characteristics



2. Contact carrying power (CW)

Max. 150 W (whith heat sink) (at 2 GHz, Impedance 50Ω, V.S.W.R. Max. 1.15, at 20°C 68°F) Max. 100 W (whithout heat sink) (at 2 GHz, Impedance 50Ω, V.S.W.R. Max. 1.15, at 20°C 68°F)



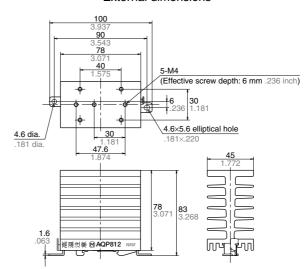
Measuring conditions:

Heat sink (AQP-HS-SJ20A) is used. (Reference: 2.9°C 37.22°F/W)

Heat sink (AQP-HS-SJ20A) (mm inch)



External dimensions



General tolerance: ±0.1 ±.004

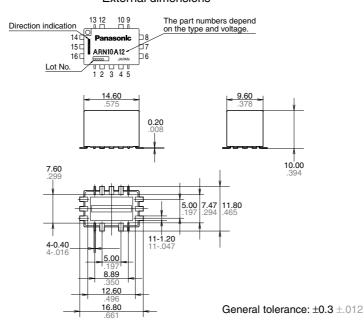
DIMENSIONS (mm inch)

The CAD data of the products with a CAD Data mark can be downloaded from: http://industrial.panasonic.com/ac/e/

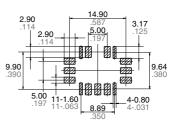
CAD Data



External dimensions



PC board pattern



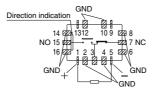
Schematic

Single side stable type/Standard contact type

Direction indication

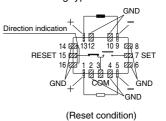
(Deenergized condition)

Single side stable type/Reversed contact type



(Deenergized condition)

2 coil latching type/Standard contact type



NOTES

1. Regarding cautions for use, please refer to "GENERAL APPLICATION GUIDELINES" on our general catalog.

2. Coil operating power

Pure DC current should be applied to the coil. If it includes ripple, the ripple factor should be less than 5%. However, check it with the actual circuit since the characteristics may be slightly different. The wave form of power should be rectangular. To ensure accurate operation, the voltage on both sides of the coil should be $\pm 5\%$ (at 20°C 68°F) of the nominal coil voltage. Also, please note that the pick-up and drop-out voltages (set and reset voltages) will change depending on operation temperature and conditions of use.

3. Coil connection

This relay is polarized relay, the coil voltage must be applied with correct polarity.

4. External magnetic field

Since RN relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that condition.

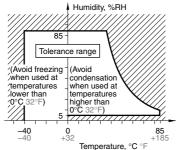
5. Cleaning

This product is not sealed type, therefore washing is not allowed.

6. Conditions for operation, transport and storage

- 1) Temperature: -40 to $+85^{\circ}$ C -40 to $+185^{\circ}$ F (But allowable temperature is from -40 to $+60^{\circ}$ C -40 to $+140^{\circ}$ F at our standard packing condition.)
- 2) Humidity: 5 to 85% R.H. (Avoid freezing and condensation.) The humidity range varies with the temperature. Use within the range indicated in the graph below.
- 3) Atmospheric pressure: 86 to 106 kPa

Temperature and humidity range for usage, transport, and storage



4) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.

5) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.

6) Low temperature and low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.

7) Storage requirements

Since the relay is sensitive to humidity, it comes in sealed antihumidity packaging. However, when storing, please be careful of the following.

- (1) Please use promptly once the anti-humidity pack is opened.
- (2) When storing for a log period after opening the anti-humidity

pack, storage in anti-humidity packaging with an antihumidity bag to which silica gel has been added, is recommended. *Furthermore, if the relay is solder mounted when it has been subjected to excessive humidity, cracks and leaks can occur. Be sure to mount the relay under the required mounting conditions.

7. Soldering

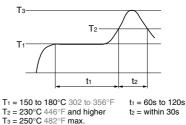
Please meet the following conditions if this relay is to be automatically soldered.

1) Position of measuring temperature



A: Surface of PC board where relay is mounted.

2) IR (infrared reflow) soldering method



Mounting cautions

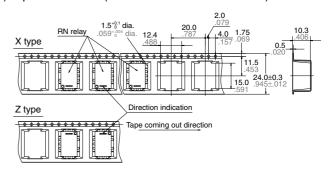
Rise in relay temperature depends greatly on the component mix on a given PC board and the heating method of the reflow equipment. Therefore, please test beforehand using actual equipment to ensure that the temperature where the relay terminals are soldered and the temperature at the top of the relay case are within the conditions given above.

- 3) Please meet the following conditions if this relay is to be soldered by hand.
- (1) Max. 260°C 500°F (solder temperature), within 10 seconds (soldering time)
- (2) Max. 350°C 662°F (solder temperature), within 3 seconds (soldering time)

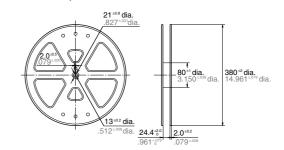
The effect on the relay depends on the actual PC board used. Please verify the PC board to be used.

8. Tape and reel packing

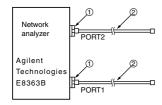
1) Tape dimensions (General tolerance: $\pm 0.1 \pm .004$)



2) Dimensions of plastic reel



9. Measuring method of high frequency characteristics (Impedance 50Ω)

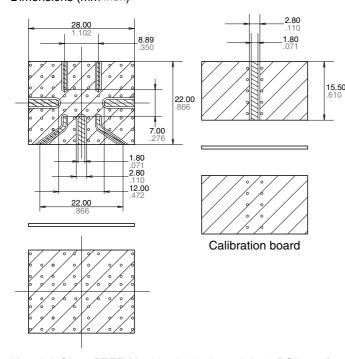


Connect connectors 1 and 2 respectively to PORT 1 and PORT 2. Perform calibration using the 3.5 mm calibration kit (HP85052B).

No.	Product name	Contents
1	Agilent 85130-60011	Adapter 2.4mm-3.5mm female .095inch138inch female
2	SUHNER SUCOFLEX104	Cable 3.5mm-3.5mm male .138inch138inch male

After calibration, connect the D.U.T. board and measure. However, connectors other than those for measurement should be connected with a 50Ω termination resistor.

D.U.T. board Dimensions (mm inch)



Material: Glass PTFE (double-sided, through hole PC board)

R-4737 (manufactured by our company) Board thickness: t = 0.8 mm .031 inch Copper plating thickness: $18 \mu \text{m}$

Connector (SMA type)

Product name: 01K1808-00 (Waka Manufacturing Co., Ltd.) Insertion loss compensation: The insertion loss of relay itself is given by subtracting the insertion loss of calibration board.

10. Others

1) The switching lifetime is defined under the standard test condition specified in the JIS* C 5442 standard (temperature 15 to 35°C 59 to 95°F, humidity 25 to 75%RH). Check this with the real device as it is affected by coil driving circuit, load type, activation frequency, activation phase, ambient conditions and other factors. *JIS: Japanese Industrial Standards

Also, be especially careful of loads such as those listed below.

- When used for AC load-operating and the operating phase is synchronous, rocking and fusing can easily occur due to contact shifting.
- When high-frequency opening and closing of the relay is performed with a load that causes arcs at the contacts, nitrogen and oxygen in the air is fused by the arc energy and HNO₃ is formed. This can corrode metal materials.

Three countermeasures for these are listed here.

- (1) Incorporate an arc-extinguishing circuit.
- (2) Lower the operating frequency
- (3) Lower the ambient humidity
- 2) Use the relay within specifications such as coil rating, contact rating and on/off service life. If used beyond limits, the relay may overheat, generate smoke or catch fire.
- 3) Be careful not to drop the relay. If accidentally dropped, carefully check its appearance and characteristics before use.
- 4) Be careful to wire the relay correctly. Otherwise, malfunction, overheat, fire or other trouble may occur.
- 5) If a relay stays on in a circuit for many months or years at a time without being activated, circuit design should be reviewed so that the relay can remain non-excited. A coil that receives current all the time heats, which degrades insulation earlier than expected. A latching type relay is recommended for such circuits.
- 6) To ensure accurate operation of the latching type amidst surrounding temperature changes and other factors that might affect the set and reset pulse times, we recommend a coil impress set and reset pulse width of at least 30 ms at the rated operation voltage.
- 7) The latching type relay is shipped in the reset position. But jolts during transport or impacts during installation can change the reset position. It is, therefore, advisable to build a circuit in which the relay can be initialized (set and reset) just after turning on the power.
- 8) If silicone materials (e.g., silicone rubbers, silicone oils, silicone coating agents, silicone sealers) are used in the vicinity of the relay, the gas emitted from the silicone may adhere to the contacts of the relay during opening and closing and lead to improper contact. If this is the case, use a material other than silicone.

For general cautions for use, please refer to the "General Application Guidelines".